

Title (en)

Composite thin film insulator, manufacturing method thereof, and electric rotating machines using the composite thin film insulator

Title (de)

Dünner Verbundfolienisolator, Verfahren zu seiner Herstellung und elektrische Drehmaschinen mit dem Verbundfolienisolator

Title (fr)

Isolateur en feuille composite mince, son procédé de fabrication et machine électrique rotative le contenant

Publication

EP 0672521 B1 19990526 (EN)

Application

EP 95301784 A 19950317

Priority

JP 4824394 A 19940318

Abstract (en)

[origin: EP0672521A1] The present invention is aimed at improving adhering property of a thin film insulator, which is used for insulation among layers and to the earth of electric apparatus such as induction motor coils, between mutual thin film insulators and between the thin film insulator and a conductive body. The thin film insulator relating to the present invention is composed of a polyester film 1a, polyester unwoven cloth sheets 1b, a reconstituted mica paper 2, and epoxy resin 3, wherein the mica paper 2 is adhered on a surface of a laminated plastic film.unwoven cloth sheet 1, which is formed previously by adhering the polyester unwoven cloth sheet 1b to each of upper and lower surfaces of the polyester plastic film 1a without any binder by heating and melting, by impregnating the epoxy resin 3 into the polyester unwoven cloth sheet 1b and the mica paper and heating for curing. <IMAGE>

IPC 1-7

B32B 19/06; **B32B 27/12**; **H01B 3/04**; **H02K 3/32**

IPC 8 full level

B32B 19/06 (2006.01); **H01B 3/04** (2006.01); **H02K 3/32** (2006.01)

CPC (source: EP US)

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Citation (examination)

- EP 0413179 A2 19910220 - HITACHI LTD [JP]
- International Electrotechnical Commission (IEC) Standard, Bureau Central de la Commission Electrotechnique Internationale, Publication 85, Second edition, Geneva, 1984 pages 3, 7

Cited by

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